## 4 Mbit (512K x 8) Static RAM

## Features

- Temperature ranges
a Commercial: $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
a Industrial/Automotive $-\mathrm{A}:-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
a Automotive-E: $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
- High Speed
$\square \mathrm{t}_{\mathrm{AA}}=10 \mathrm{~ns}$
- Low Active Power

口 324 mW (max)
■ 2.0V Data Retention
■ Automatic Power Down when Deselected

- TTL-compatible Inputs and Outputs
- Easy Memory Expansion with $\overline{\mathrm{CE}}$ and $\overline{\mathrm{OE}}$ features


## Functional Description

The CY7C1049CV33 is a high performance CMOS Static RAM organized as 524,288 words by eight bits. Easy memory expansion is provided by an active LOW Chip Enable ( $\overline{\mathrm{CE}}$ ), an active LOW Output Enable ( $\overline{\mathrm{OE}})$, and three-state drivers. Writing to the device is accomplished by taking Chip Enable ( $\overline{\mathrm{CE}}$ ) and Write Enable ( $\overline{\mathrm{WE}}$ ) inputs LOW. Data on the eight I/O pins (I/O $\mathrm{O}_{0}$ through $\mathrm{I} / \mathrm{O}_{7}$ ) is then written into the location specified on the address pins ( $\mathrm{A}_{0}$ through $\mathrm{A}_{18}$ ).
Reading from the device is accomplished by taking Chip Enable ( $\overline{\mathrm{CE}}$ ) and Output Enable ( $\overline{\mathrm{OE})}$ LOW while forcing Write Enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins appear on the I/O pins.

The eight input and output pins $\left(1 / O_{0}\right.$ through $\left.I / O_{7}\right)$ are placed in a high impedance state when the device is deselected (CE HIGH), the outputs are disabled (OE HIGH), or during a write operation (CE LOW, and WE LOW).

The CY7C1049CV33 is available in standard 400-mil-wide 36-pin SOJ package and 44-pin TSOP II package with center power and ground (revolutionary) pinout.
For best practice recommendations, refer to the Cypress application note AN1064, SRAM System Guidelines.

## Logic Block Diagram



## Contents

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## Pin Configuration

Figure 1. 36-Pin SOJ (Top View)


Figure 2. 44-Pin TSOP II (Top View)

| NC[ 1 | 44 | $\square \mathrm{NC}$ |
| :---: | :---: | :---: |
| NCL | 43 | $\square \mathrm{NC}$ |
| $\mathrm{A}_{0}{ }^{\text {a }}$ | 42 | $\square \mathrm{NC}$ |
| $\mathrm{A}_{1}$ | 41 | $\square A_{18}$ |
| $A_{2}$ | 40 | $\square A_{17}$ |
| $\mathrm{A}_{3}$ | 39 | - $A_{16}$ |
| $\mathrm{A}_{4}$ | 38 | $A_{15}$ |
| CE | 37 | $\square \overline{O E}$ |
| $1 / \mathrm{O}_{0}$ | 36 | $\square \mathrm{I} / \mathrm{O}_{7}$ |
| $/ \mathrm{O}_{1}-10$ | 35 | $\square 1 / \mathrm{O}_{6}$ |
| $V_{\text {CC }} 11$ | 34 | $\square \mathrm{V}_{\mathrm{SS}}$ |
| $\mathrm{V}_{\text {SS }} 12$ | 33 | $\square \mathrm{V}_{\mathrm{CC}}$ |
| $/ \mathrm{O}_{2}-13$ | 32 | $\square \mathrm{I} / \mathrm{O}_{5}$ |
| $/ \mathrm{O}_{3}-14$ | 31 | $\mathrm{l} / \mathrm{O}_{4}$ |
| WE $\square_{15}$ | 30 | - $A_{14}$ |
| $\mathrm{A}_{5} \square_{16}$ | 29 | $\mathrm{A}_{13}$ |
| $\mathrm{A}_{6}-17$ | 28 | $\square A_{12}$ |
| $\mathrm{A}_{7} \mathrm{C}_{18}$ | 27 | $\square \mathrm{A}_{11}$ |
| $\mathrm{A}_{8} \square^{19}$ | 26 | $\square A_{10}$ |
| A9 $\square 20$ | 25 | $\square$ NC |
| NC 21 | 24 | $\square \mathrm{NC}$ |
| NC $\square_{2}$ | 23 | NC |

## Selection Guide

| Description |  | $\mathbf{- 1 0}$ | $\mathbf{- 1 2}$ | $\mathbf{- 1 5}$ | Unit |
| :--- | :--- | :---: | :---: | :---: | :---: |
| Maximum Access Time |  | 10 | 12 | 15 | ns |
| Maximum Operating Current | Commercial | 90 | 85 | - | mA |
|  | Industrial/Automotive-A | 100 | 95 | - | mA |
|  | Automotive-E | - | - | 95 | mA |
| Maximum CMOS Standby Current | Commercial/Industrial/ Automotive-A | 10 | 10 | - | mA |
|  | Automotive-E | - | - | 15 | mA |

## Pin Definitions

| Pin Name | 36-SOJ <br> Pin Number | 44 TSOP-II <br> Pin Number | I/O Type | Description |
| :---: | :---: | :---: | :---: | :--- | \left\lvert\, | $\mathrm{A}_{0}-\mathrm{A}_{18}$ | $1-5,14-18$, <br> $20-24,32-35$ | $3-7,16-20$, <br> $26-30,38-41$ | Input |
| :---: | :---: | :---: | :---: |
| $\mathrm{I} / \mathrm{O}_{0}-\mathrm{I} / \mathrm{O}_{7}$ | $7,8,11,12,25$, <br> $26,29,30$ | $9,10,13,14$, <br> $31,32,35,36$ | Input/Output |
| $\mathrm{NC}^{[1]}$ | 19,36 | $1,2,21,22,23,2$ <br> $4,25,42,43,44$ | No Connect |
| $\overline{\mathrm{WE}}$ | 13 | 15 | Input/Control |
| on operation |  |  |  | | No connects. This pin is not connected to the die |
| :--- |
| $\overline{\mathrm{CE}}$ |
| $\overline{\mathrm{OE}}$ |
| Write Enable input, active LOW. When selected LOW, a WRITE is |
| conducted. When selected HIGH, a READ is conducted. |\right.

Note

1. NC pins are not connected on the die.

## Maximum Ratings

Exceeding maximum ratings may impair the useful life of the device. These user guidelines are not tested.

Storage Temperature $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Ambient Temperature with
Power Applied $\qquad$ $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Supply Voltage on $\mathrm{V}_{\mathrm{CC}}$ to Relative $\mathrm{GND}^{[2]}-0.5 \mathrm{~V}$ to +4.6 VDC
Voltage Applied to Outputs in High-Z State ${ }^{[2]}$ $\qquad$ -0.5 V to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$

Input Voltage ${ }^{[2]}$ $\qquad$ -0.5 V to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$

Current into Outputs (LOW) .20 mA
Operating Range

| Range | Ambient Temperature | $\mathbf{V}_{\text {CC }}$ |
| :--- | :---: | :---: |
| Commercial | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | $3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ |
| Industrial $/$ <br> Automotive-A | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |
| Automotive-E | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |

## Electrical Characteristics

Over the Operating Range

| Parameter | Description | Test Conditions |  | -10 |  | -12 |  | -15 |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Max | Min | Max | Min | Max |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage | $\mathrm{V}_{\mathrm{CC}}=$ Min.; $\mathrm{I}_{\mathrm{OH}}=-4.0 \mathrm{~mA}$ |  | 2.4 |  | 2.4 |  | 2.4 |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage | $\mathrm{V}_{\mathrm{CC}}=\mathrm{Min} .$, ; $\mathrm{IOL}=8.0 \mathrm{~mA}$ |  |  | 0.4 |  | 0.4 |  | 0.4 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage |  |  | 2.0 | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}} \\ & +0.3 \end{aligned}$ | 2.0 | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}} \\ & +0.3 \end{aligned}$ | 2.0 | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}} \\ & +0.3 \end{aligned}$ | V |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage ${ }^{[2]}$ |  |  | -0.3 | 0.8 | -0.3 | 0.8 | -0.3 | 0.8 | V |
| $\mathrm{I}_{\mathrm{IX}}$ | Input Load Current | $\mathrm{GND} \leq \mathrm{V}_{1} \leq \mathrm{V}_{\mathrm{CC}}$ | Com'I/Ind'I/ Auto-A | -1 | +1 | -1 | +1 |  |  | $\mu \mathrm{A}$ |
|  |  |  | Auto-E |  |  |  |  | -20 | +20 |  |
| ${ }^{\text {CC }}$ | $\mathrm{V}_{\mathrm{CC}}$ Operating Supply Current | $\begin{aligned} & V_{C C}=\text { Max. }, \\ & f=f_{M A X}=1 / t_{R C} \end{aligned}$ | Com'l |  | 90 |  | 85 |  |  | mA |
|  |  |  | Ind'//Auto-A |  | 100 |  | 95 |  |  |  |
|  |  |  | Auto-E |  |  |  |  |  | 95 |  |
| $\mathrm{I}_{\text {SB1 }}$ | Automatic CE <br> Power Down Current <br> -TTL Inputs | $\begin{aligned} & \text { Max. } V_{\mathrm{CC}}, \overline{C E} \geq \mathrm{V}_{\mathrm{IH}} ; \\ & \mathrm{V}_{\mathrm{IN}} \geq \mathrm{V}_{\mathrm{IH}} \text { or } \\ & \mathrm{V}_{\mathrm{IN}} \leq \mathrm{V}_{\mathrm{IL}}, f=f_{\mathrm{MAX}} \end{aligned}$ | Com'I/Ind'I/ Auto-A |  | 40 |  | 40 |  |  | mA |
|  |  |  | Auto-E |  |  |  |  |  | 45 | mA |
| $\mathrm{I}_{\text {SB2 }}$ | Automatic CE <br> Power Down Current <br> -CMOS Inputs | $\begin{aligned} & \text { Max. } \mathrm{V}_{\mathrm{CC}}, \\ & \mathrm{CE} \geq \mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}, \\ & \mathrm{~V}_{\text {IN }} \geq \mathrm{V}_{\mathrm{CC}}-0.3 \mathrm{~V}, \\ & \text { or } \mathrm{V}_{\text {IN }} \leq 0.3 \mathrm{~V}, \mathrm{f}=0 \end{aligned}$ | Com'I/Ind’I/ Auto-A |  | 10 |  | 10 |  |  | mA |
|  |  |  | Auto-E |  |  |  |  |  | 15 | mA |

## Capacitance

Tested initially and after any design or process changes that may affect these parameters.

| Parameter | Description | Test Conditions | Max | Unit |
| :--- | :--- | :--- | :--- | :---: |
| $\mathrm{C}_{\mathrm{IN}}$ | Input Capacitance | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=1 \mathrm{MHz}$, | 8 | pF |
| $\mathrm{C}_{\mathrm{OUT}}$ | V | $\mathrm{CC}=3.3 \mathrm{~V}$ | 8 | pF |

## Thermal Resistance

Tested initially and after any design or process changes that may affect these parameters.

| Parameter | Description | Test Conditions | 36-Pin SOJ | 44-TSOP-II | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: |
| $\Theta_{\mathrm{JA}}$ | Thermal Resistance (Junction <br> to Ambient) | Test conditions follow standard <br> test methods and procedures for | 46.51 | 41.66 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | measuring thermal impedance, <br> per EIA / JESD51. | 18.8 | 10.56 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |  |
| $\Theta_{\mathrm{JC}}$ | Thermal Resistance <br> (Junction to Case) |  |  |  |  |

[^0]Figure 3. AC Test Loads and Waveforms ${ }^{[3]}$


## AC Switching Characteristics

Over the Operating Range ${ }^{[5]}$

| Parameter | Description | -10 |  | -12 |  | -15 |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max | Min | Max |  |
| Read Cycle |  |  |  |  |  |  |  |  |
| $\mathrm{t}_{\text {power }}{ }^{\text {[6] }}$ | $\mathrm{V}_{\text {CC }}$ (typical) to the first access | 100 |  | 100 |  | 100 |  | $\mu \mathrm{s}$ |
| $\mathrm{t}_{\mathrm{RC}}$ | Read Cycle Time | 10 |  | 12 |  | 15 |  | ns |
| $\mathrm{t}_{\mathrm{AA}}$ | Address to Data Valid |  | 10 |  | 12 |  | 15 | ns |
| $\mathrm{t}_{\text {OHA }}$ | Data Hold from Address Change | 3 |  | 3 |  |  | 3 | ns |
| $t_{\text {ACE }}$ | $\overline{\mathrm{CE}}$ LOW to Data Valid |  | 10 |  | 12 |  | 15 | ns |
| $\mathrm{t}_{\text {DOE }}$ | $\overline{\mathrm{OE}}$ LOW to Data Valid |  | 5 |  | 6 |  | 7 | ns |
| t Lzoe | $\overline{\mathrm{OE}}$ LOW to Low-Z | 0 |  | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {HZOE }}$ | $\overline{\mathrm{OE}}$ HIGH to High-Z ${ }^{[7,8]}$ |  | 5 |  | 6 |  | 7 | ns |
| tlzce | $\overline{\mathrm{CE}}$ LOW to Low-Z ${ }^{[8]}$ | 3 |  | 3 |  | 3 |  | ns |
| $\mathrm{t}_{\text {HZCE }}$ | $\overline{\mathrm{CE}}$ HIGH to High-Z ${ }^{[7, ~ 8]}$ |  | 5 |  | 6 |  | 7 | ns |
| $\mathrm{t}_{\mathrm{PU}}$ | $\overline{\mathrm{CE}}$ LOW to Power Up | 0 |  | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {PD }}$ | $\overline{\mathrm{CE}}$ HIGH to Power Down |  | 10 |  | 12 |  | 15 | ns |
| Write Cycle ${ }^{[9,10]}$ |  |  |  |  |  |  |  |  |
| ${ }^{\text {tw }}$ w | Write Cycle Time | 10 |  | 12 |  | 15 |  | ns |
| $\mathrm{t}_{\text {SCE }}$ | $\overline{\mathrm{CE}}$ LOW to Write End | 7 |  | 8 |  | 10 |  | ns |
| $\mathrm{t}_{\text {AW }}$ | Address Setup to Write End | 7 |  | 8 |  | 10 |  | ns |
| $\mathrm{t}_{\mathrm{HA}}$ | Address Hold from Write End | 0 |  | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {SA }}$ | Address Setup to Write Start | 0 |  | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {PWE }}$ | $\overline{\text { WE Pulse Width }}$ | 7 |  | 8 |  | 10 |  | ns |
| $\mathrm{t}_{\text {SD }}$ | Data Setup to Write End | 5 |  | 6 |  | 7 |  | ns |
| $\mathrm{t}_{\mathrm{HD}}$ | Data Hold from Write End | 0 |  | 0 |  | 0 |  | ns |
| t LZWE | $\overline{\text { WE }}$ HIGH to Low-Z ${ }^{[8]}$ | 3 |  | 3 |  | 3 |  | ns |
| $\mathrm{t}_{\text {HZWE }}$ | $\overline{\mathrm{WE}}$ LOW to High-Z ${ }^{[7,8]}$ |  | 5 |  | 6 |  | 7 | ns |

## Notes

5. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5 V , input pulse levels of 0 to 3.0 V ,
6. $t_{\text {POWER }}$ gives the minimum amount of time that the power supply should be at stable, typical $\mathrm{V}_{\mathrm{CC}}$ values until the first memory access can be performed.
7. $t_{H Z O E}, t_{H Z C E}$, and $t_{H Z W E}$ are specified with a load capacitance of 5 pF as in part (d) of AC Test Loads. Transition is measured $\pm 500 \mathrm{mV}$ from steady-state voltage.
8. At any given temperature and voltage condition, $t_{\text {HZCE }}$ is less than $t_{\text {LZCE }}, t_{H Z O E}$ is less than $t_{\text {LZOE }}$, and $t_{H Z W E}$ is less than $t_{L Z W E}$ for any given device.
9. The internal Write time of the memory is defined by the overlap of CE LOW, and WE LOW. CE and WE must be LOW to initiate a Write, and the transition of either of these signals can terminate the Write. The input data setup and hold timing should be referenced to the leading edge of the signal that terminates the Write.
10. The minimum Write cycle time for Write Cycle No. 3 (WE controlled, $\overline{O E}$ LOW) is the sum of $t_{\text {HZWE }}$ and $t_{S D}$.

## Switching Waveforms

Figure 4. Read Cycle No. 1 (Address Transition Controlled) ${ }^{[11,12]}$


Figure 5. Read Cycle No. 2 ( $\overline{\mathrm{OE}}$ Controlled) ${ }^{[12,13]}$


Figure 6. Write Cycle No. 1 ( $\overline{\mathrm{WE}}$ Controlled, $\overline{\mathrm{OE}}$ HIGH During Write) ${ }^{[14,15]}$


## Notes

11. Device is continuously selected. $\overline{\mathrm{OE}}, \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IL}}$.
12. $\overline{\text { WE }}$ is HIGH for read cycles.
13. Address valid before or similar to $\overline{\mathrm{CE}}$ transition LOW.
14. Data $\mathrm{I} / \mathrm{O}$ is high impedance if $\overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IL}}$.
15. If $\overline{\text { CE }}$ goes HIGH simultaneously with WE HIGH, the output remains in high impedance state.
16. During this period, the I/Os are in output state. Do not apply input signals.

Switching Waveforms (continued)
Figure 7. Write Cycle No. 2 ( $\overline{\mathrm{WE}}$ Controlled, $\overline{\mathrm{OE}}$ LOW) ${ }^{[15]}$


Truth Table

| $\overline{\mathbf{C E}}$ | $\overline{\mathrm{OE}}$ | $\overline{\mathrm{WE}}$ | $\mathbf{I / \mathbf { O } _ { \mathbf { 0 } } - \mathbf { I } / \mathbf { O } _ { \mathbf { 7 } }}$ | Mode | Power |
| :---: | :---: | :---: | :--- | :--- | :--- |
| H | X | X | High-Z | Power Down | Standby ( $\left.\mathrm{I}_{\mathrm{SB}}\right)$ |
| L | L | H | Data Out | Read | Active ( $\left.\mathrm{I}_{\mathrm{CC}}\right)$ |
| L | X | L | Data In | Write | Active (I $\left.\mathrm{I}_{\mathrm{CC}}\right)$ |
| L | H | H | High-Z | Selected, Outputs Disabled | Active (I $\left.\mathrm{I}_{\mathrm{CC}}\right)$ |

## Ordering Information

| Speed <br> (ns) | Ordering Code | Package <br> Diagram | Package Type | Operating <br> Range |
| :---: | :--- | :---: | :--- | :---: |
| 10 | CY7C1049CV33-10VXC | $51-85090$ | 36-Pin (400-Mil) Molded SOJ (Pb-Free) | Commercial |
|  | CY7C1049CV33-10ZXI | $51-85087$ | $44-$ Pin TSOP II (Pb-Free) | Industrial |
|  | CY7C1049CV33-10VXA | $51-85090$ | $36-P i n ~(400-M i l)$ Molded SOJ (Pb-Free) | Automotive-A |
| 12 | CY7C1049CV33-12VXC | $51-85090$ | $36-P i n ~(400-M i l)$ Molded SOJ (Pb-Free) | Commercial |
|  | CY7C1049CV33-12ZSXA | $51-85087$ | $44-P i n ~ T S O P ~ I I ~(P b-F r e e) ~$ | Automotive-A |
| 15 | CY7C1049CV33-15VXE | $51-85090$ | 36-Pin (400-Mil) Molded SOJ (Pb-Free) | Automotive-E |
|  | CY7C1049CV33-15ZSXE | $51-85087$ | $44-P i n ~ T S O P ~ I I ~(P b-F r e e) ~$ |  |

## Package Diagrams

Figure 8. 36-Pin (400-Mil) Molded SOJ V36, 51-85090


DIMENSIONS IN INCHES MIN.


MAX.

Figure 9. 44-Pin TSOP II, 51-85087


$\qquad$ EJECTOR PIN BOTTOM VIEW


DIMENSION IN MM (INCH)
MAX
MIN.


51-85087 *B

## Document History Page

Document Title: CY7C1049CV33, 4 Mbit (512K x 8) Static RAM
Document Number: 38-05006

| Rev. | ECN | Orig. of Change | Submission Date | Description of Change |
| :---: | :---: | :---: | :---: | :---: |
| ** | 112569 | HGK | 03/06/02 | New data sheet |
| *A | 114091 | DFP | 04/25/02 | Changed Tpower unit from ns to $\mu \mathrm{s}$ |
| *B | 116479 | CEA | 09/16/02 | Add applications foot note to data sheet, page 1. |
| *C | 262949 | RKF | See ECN | Added Automotive-E Specs Added $\Theta_{J A}$ and $\Theta_{J C}$ values on Page \#3. |
| *D | 300091 | RKF | See ECN | Added -20-ns Speed bin |
| *E | 344595 | SYT | See ECN | Added Pb-Free package on page \#8 <br> Removed shading for CY7C1049CV33-15ZSXE in the ordering Information on page 9 |
| *F | 2615344 | VKN/PYRS | 12/03/08 | Added Automotive-A information Removed 8 ns and 20 ns speed bins, Changed tpower spec from $1 \mu \mathrm{~s}$ to $100 \mu \mathrm{~s}$, Updated Ordering Information table. |
| *G | 2841563 | NXR/ | 01/07/2010 | Added CY7C1049CV33-10VXA to Ordering Info table. |

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[^0]:    Notes
    2. $\mathrm{V}_{\mathrm{IL}}(\min )=-2.0 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{IH}}(\max )=\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ for pulse durations of less than 20 ns .
    3. Tested initially and after any design or process changes that may affect these parameters.

